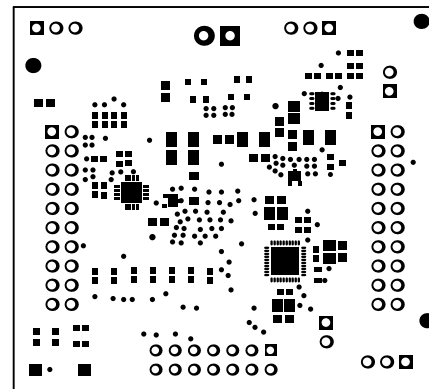
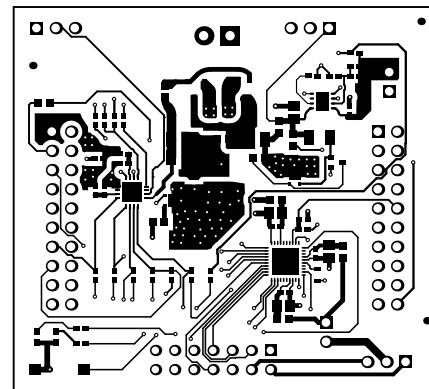


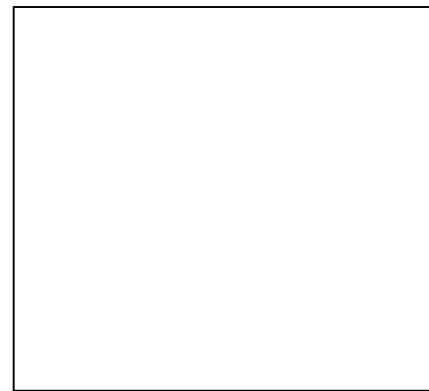
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00648		
PLOT NAME = Top Overlay	GENERATED : 9/16/2015 12:34:09 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00648		
PLOT NAME = Top Solder Mask	GENERATED : 9/16/2015 12:34:12 PM	TEXAS INSTRUMENTS	



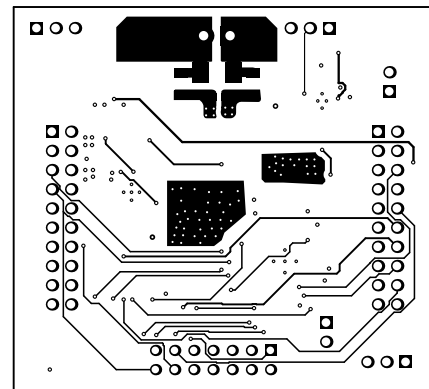
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Component Side	TID #: TIDA-00648		
PLOT NAME = Top Layer	GENERATED : 9/16/2015 12:34:15 PM	TEXAS INSTRUMENTS	



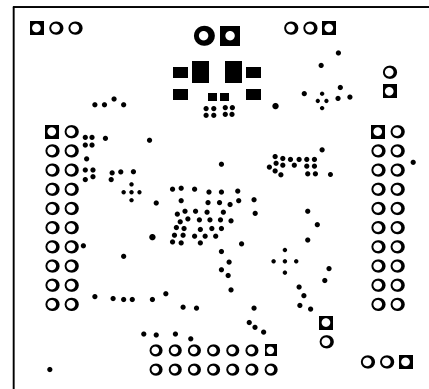
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00648		
PLOT NAME = Signal Layer 1	GENERATED : 9/16/2015 12:34:18 PM	TEXAS INSTRUMENTS	



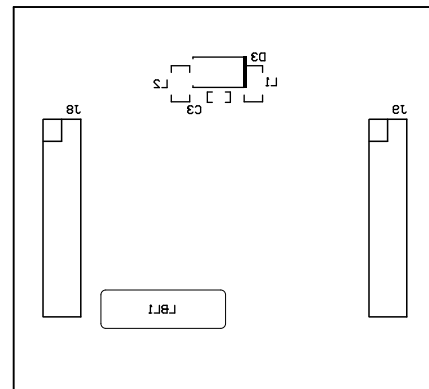
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-00648		
PLOT NAME = Signal Layer 2	GENERATED : 9/16/2015 12:34:21 PM	TEXAS INSTRUMENTS	



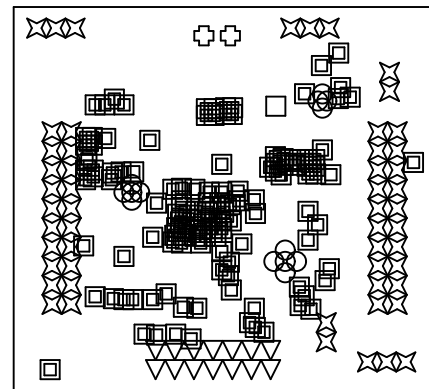
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Solder Side	TID #: TIDA-00648		
PLOT NAME = Bottom Layer	GENERATED : 9/16/2015 12:34:24 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00648		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/16/2015 12:34:27 PM	TEXAS INSTRUMENTS	

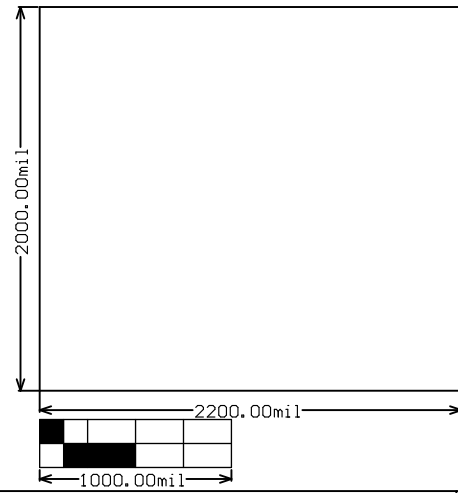


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00648		
PLOT NAME = Bottom Overlay	GENERATED : 9/16/2015 12:34:30 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	14	7.87mil (0.200mm)	PTH	Round
■	126	12.00mil (0.305mm)	PTH	Round
□	1	14.00mil (0.356mm)	PTH	Round
▽	14	39.37mil (1.000mm)	PTH	Round
⊗	53	45.28mil (1.150mm)	PTH	Round
⊕	2	50.00mil (1.270mm)	PTH	Round
	210 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00648		
PLOT NAME = Drill Drawing	GENERATED : 9/16/2015	12:34:33 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00648	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Mechanical 2	TID #: TIDA-00648		
PLOT NAME = Board Dimensions	GENERATED : 9/16/2015 12:34:36 PM	TEXAS INSTRUMENTS	

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